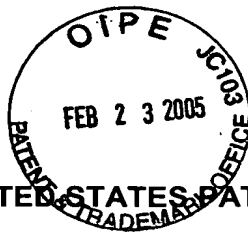


Docket No. 3008-0028  
File No. 521.41457X00  
Client No. PHCF-01094



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of :  
AOYAMA, et al. : Art Unit: 2841

Serial No: 09/892,630 :  
: Examiner: T. Dinh

Filed: June 28, 2001 :  
:

For: LEAD-FREE SOLDER, AND CONNECTION LEAD AND ELECTRICAL  
COMPONENT USING SAID LEAD-FREE SOLDER

**AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

February 23, 2005

Sir:

This Amendment is filed in response to the non-final Official Action dated November 30, 2004, the time for response to which is up to and including February 28, 2005. Please amend the above-identified application as listed below and as set forth on the following pages.

**Amendments to the Claims**

**Remarks** are included following the amendments